FORM PTO-1595 (Rev. 6-93)	PO RECO	DRI	10-20	-2000	Ī	ET U.S			F COMMERCE rademark Office	
OMB No. 0651-0011 (exp. 4/9	10/4/00						1 40	on and 1	ademark office	
To the Honorable	92268 original documents or copy thereof.									
1. Name of conveying p	2. Name and address of receiving party(ies):									
Kwang-Shik Shin Kyu-Charn Park Heung-Kwun Oh	Name:		Electronics,	Co., Ltd	·	PTC 2				
Sung-Hoi Hur				Internal Ac	ddress:				-36	
Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No									094	
3. Nature of conveyance	Street Address: 416, Maetan-dong, Paldal-gu,									
				Suwon	ı-city, Kyı	ıngki-do, Rej	public of	Korea		
		☐ Merger								
☐ Security Agreement		☐ Change o	of Name	City:		State	e	ZIP	,	
☐ Other		, v. <u>v </u>								
Execution Date:	cution Date: September 18, 2000			Additional name(s) & address attached? ☐ Yes ☒ No						
4. Application number(s				<u> </u>	,					
If this document is being filed together with a new application, the execu A. Patent Application No.(s)					the applic No.(s)	cation is:	S	eptembe	er 18, 2000	
		Additional nun	nbers attached?		678 8 No	917				
5. Name and address of party to whom correspondence concerning document should be mailed:					6. Total number of applications and registrations involved 1					
Name: Steven M	Mills									
				7. Total fee (3	37 CFR 3.41)	_\$40.0	00		
Samuels, Gauthier & Stevens LLP				☑ Enclosed						
Salitable, Gastillot & Storting 221				☐ Authorized to be charged to deposit account						
Street Address: 225 Franklin Street, Suite 3300				8. Deposit Ac	count Numb	er:				
City: Boston	State M	IA ZIP	02110	(Attach duplic	cate copy of t	this page if payir	ng by depos	it account)	
10/19/2000 DBYRNE 000	00153 09678917	DO	NOT USE TH	IIS SPACE						
01 FC:581 9. Statement and signature: To the best of my knowledge a	(40.00 OP	ormation is true a	nd correct and	any attached co	opy is a true	copy of the origi	inal docume	nt.		
Steven M. Mills Reg.No. 36,610		_	Stee	een M	ul	. (Ictol	hu 4	12000	
Name of Person Sign	_	of pages including	Signature	ttachmente and	document [3	Dat	e	ļ	

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents and Trademarks, Box Assignments Washington, D.C. 20231

K:\Samsung\130\PTO1595.FRM

Docket No.: SAM-130

ASSIGNMENT

We, Kwang-Shik Shin of 202, Samwoo Villa, 306-52, Shinrim 10-dong, Kwanak-ku, Seoul, Republic of Korea, Kyu-Charn Park of 3-1106, Life Apt., 464, Dokgok-dong, Songtan Jiyeok, Pyoungtaek-shi, Kyunggi-do, Republic of Korea, Heung-Kwun Oh of 102-803, Samik, 1 cha Apt., Geumgok-dong, Kwonsun-ku, Kyunggi-do, Republic of Korea and Sung-Hoi Hur of 5-602, Yoksam Hanshin Apt., Dogok 1-dong, Kangnam-ku, Seoul, Republic of Korea, having invented improvements in NAND-TYPE FLASH MEMORY DEVICES AND METHODS OF FABRICATING THE SAME described in an application for Letters Patent of the United States, executed by us on even date herewith, for good and valuable consideration, receipt of which is hereby acknowledged from Samsung Electronics Co., Ltd., a Korean corporation having a place of business at 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea (and hereinafter called the Assignee, which term shall include its successors and assigns), do hereby sell, assign and transfer unto the Assignce our entire right, title, and interest in and throughout the United States of America (including its territories and dependencies) and al! countries foreign thereto, in and to and under said application (which term shall include hereinafter where the context so admits all divisional, continuing, reissue and other patent applications based thereon) and the inventions (which term shall include each and every such invention, or part thereof) therein described, and any and all patents and like rights of exclusion (including extensions thereof) of any country which may be granted on or for said inventions or on said application;

And for the same consideration We do also hereby sell, assign, and transfer unto the Assignee, all our rights under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and all other treaties of like purpose in respect of said inventions and said application, and We do hereby authorize the Assignee to apply in our name or its own name or its designee for patents and like rights of exclusion on or for said inventions in all countries, claiming (if the Assignee so desires) the priority of the filing date of said application under the provisions of said Convention, Treaty or any such other Convention or Treaty;

And for the same consideration, We do hereby agree for ourselves and for our heirs, executors, and administrators, promptly upon request of the Assignee to execute and deliver without further compensation any power of attorney, assignment, original, divisional, continuing, reissue or other application or applications for patent or patents or like rights of exclusion of any country, or other lawful documents and any further assurances that may be deemed necessary or desirable by the Assignee, fully to secure to it said right, title, and interest as aforesaid in and to said inventions, applications, and said several patents and like rights of exclusion (including extensions thereof) or any of them, all, however, at the expense of the Assignee, its successors, or assigns;

And We do hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and the corresponding Official of each country foreign thereto to issue to the Assignee, any and all patents and like rights of exclusion which may be granted in any country upon said United States application on or for said inventions;

And We do hereby covenant for ourselves and our legal representatives and agree with the Assignee, that We have granted no right or license to make, use, or sell said inventions to anyone except the Assignee, that prior to the execution of this deed our right, title, and interest in and to said inventions has not been otherwise encumbered by us, and that We have not executed and will not execute any instruments in conflict herewith.

- l -

First or Sole Inventor:

Signature:

Shin kwang Shik Kwang-Shik Shin

Date: 18 Sep. 2000

Second Joint Inventor:

Signature:

K.C. Park

Date: 18 Sep. 2000

Third Joint Inventor:

Signature:

Oh, Heung Kwun Oh

Date: 18 Sep. 2000

Fourth Joint Inventor:

Signature:

Am, Lung hor

Sung-Hoi Hur

Date: 18 Sep 2000

DOCKET NO. SAM-130 K:\Samsung\130\assignment.wpd